

# Medium Power Transistor (32V, 1A)

## 2SD1664 / 2SD1858

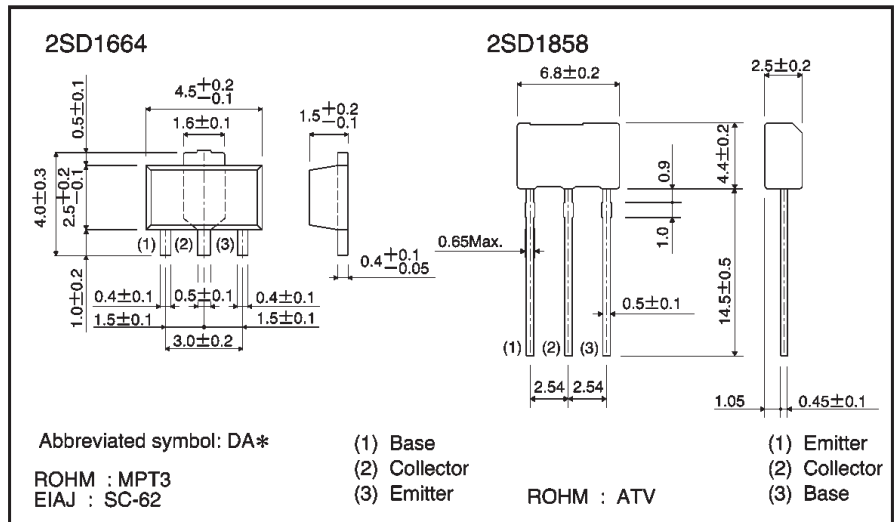
●Features

- 1) Low  $V_{CE(sat)}$ ,  $V_{CE(sat)} = 0.15V$  (typical).  
( $I_c/I_b = 500mA/50mA$ )
- 2) Complements the  
2SB1132 / 2SB1237.

●Structure

Epitaxial planar type  
NPN silicon transistor

●External dimensions (Units: mm)



\* Denotes hFE

●Absolute maximum ratings ( $T_a = 25^\circ C$ )

Parameter	Symbol	Limits	Unit		
Collector-base voltage	$V_{CBO}$	40	V		
Collector-emitter voltage	$V_{CEO}$	32	V		
Emitter-base voltage	$V_{EBO}$	5	V		
Collector current	$I_c$	1	A (DC)		
		2	A (Pulse) *1		
Collector power dissipation	2SD1664	$P_c$	0.5	W *2	
			2		*3
			1		
2SD1858					
Junction temperature	$T_j$	150	$^\circ C$		
Storage temperature	$T_{stg}$	-55~+150	$^\circ C$		

\*1  $P_w=20ms$ , duty=1 / 2

\*2 When mounted on a 40 × 40 × 0.7 mm ceramic board.

\*3 When it is mounted on the copper clad PCB (1.7mm thick) with land size for collector 1 square CM or larger.

●Electrical characteristics (Ta = 25°C)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Conditions
Collector-base breakdown voltage	$BV_{CBO}$	40	—	—	V	$I_C=50\mu A$
Collector-emitter breakdown voltage	$BV_{CEO}$	32	—	—	V	$I_C=1mA$
Emitter-base breakdown voltage	$BV_{EBO}$	5	—	—	V	$I_E=50\mu A$
Collector cutoff current	$I_{CBO}$	—	—	0.5	$\mu A$	$V_{CB}=20V$
Emitter cutoff current	$I_{EBO}$	—	—	0.5	$\mu A$	$V_{EB}=4V$
DC current transfer ratio	$h_{FE}$	82	—	390	—	$V_{CE}=3V, I_C=100mA$
Collector-emitter saturation voltage	$V_{CE(sat)}$	—	0.15	0.4	V	$I_C/I_B=500mA/50mA$
Transition frequency	$f_T$	—	150	—	MHz	$V_{CE}=5V, I_E=-50mA, f=100MHz$
Output capacitance	$C_{ob}$	—	15	—	pF	$V_{CB}=10V, I_E=0A, f=1MHz$

●Packaging specifications and  $h_{FE}$

Type	$h_{FE}$	Package	Taping	
		Code	T100	TV2
		Basic ordering unit (pieces)	1000	2500
2SD1664	PQR	○	—	—
2SD1858	PQR	—	○	—

$h_{FE}$  values are classified as follows :

Item	P	Q	R
$h_{FE}$	82~180	120~270	180~390

●Electrical characteristic curves

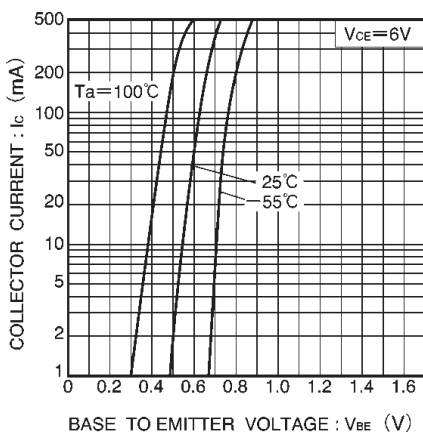


Fig.1 Grounded emitter propagation characteristics

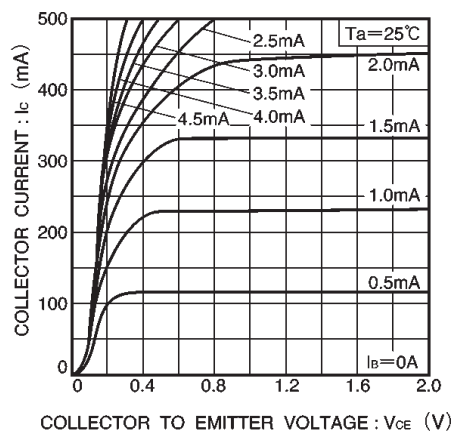


Fig.2 Grounded emitter output characteristics

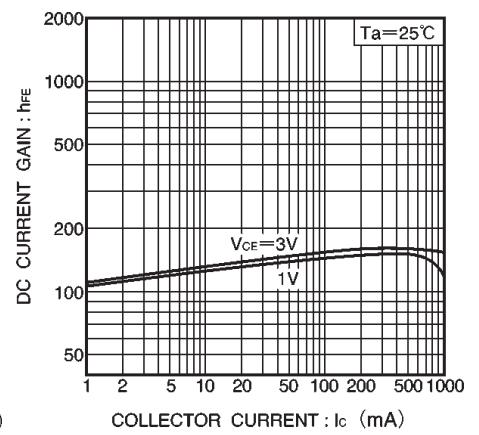


Fig.3 DC current gain vs. collector current ( I )

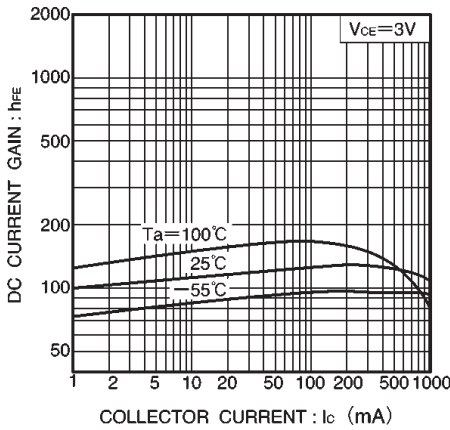


Fig.4 DC current gain vs. collector current ( I )

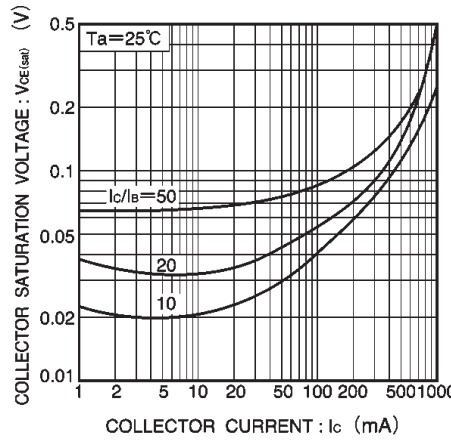


Fig.5 Collector-emitter saturation voltage vs. collector current ( I )

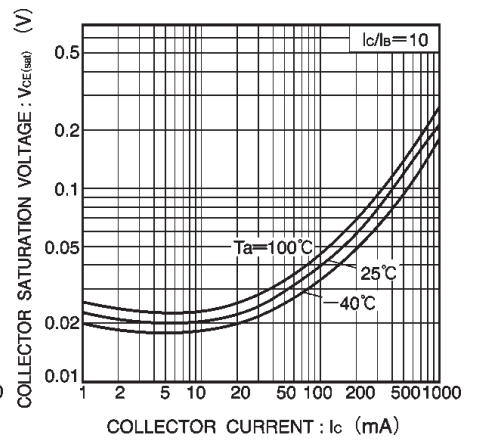


Fig.6 Collector-emitter saturation voltage vs. collector current ( I )

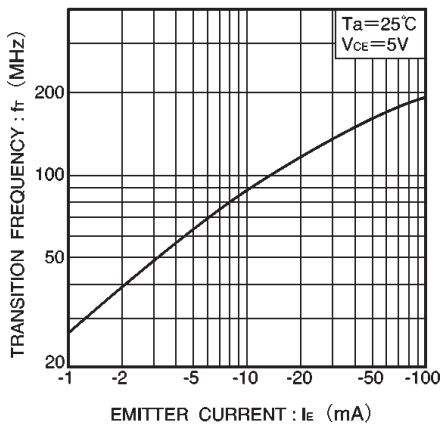


Fig.7 Gain bandwidth product vs. emitter current

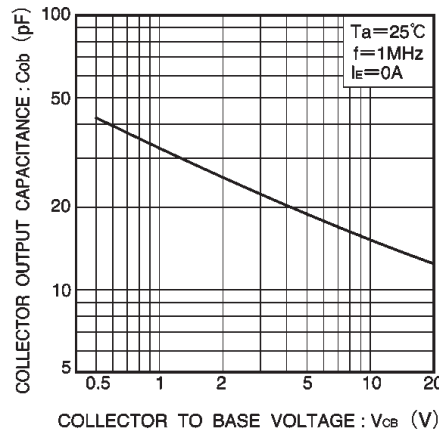


Fig.8 Collector output capacitance vs. collector-base voltage

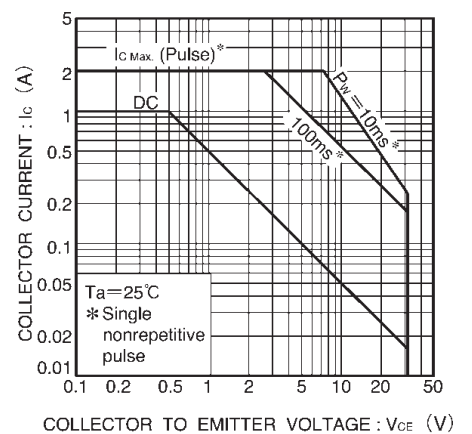


Fig.9 Safe operating area (2SD1664)

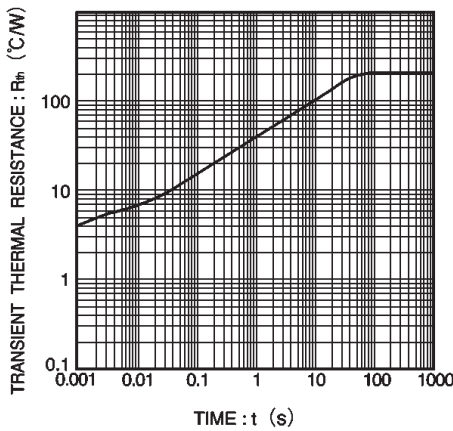


Fig.10 Transient thermal resistance (2SD1664)

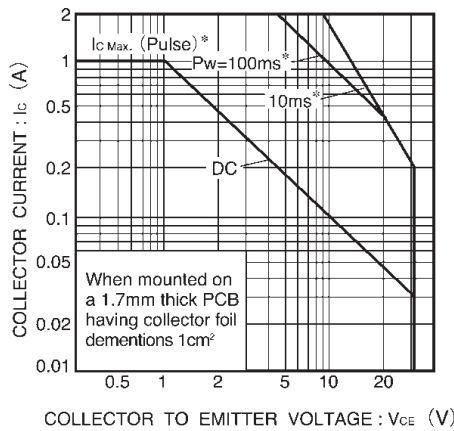


Fig.11 Safe operating area (2SD1858)

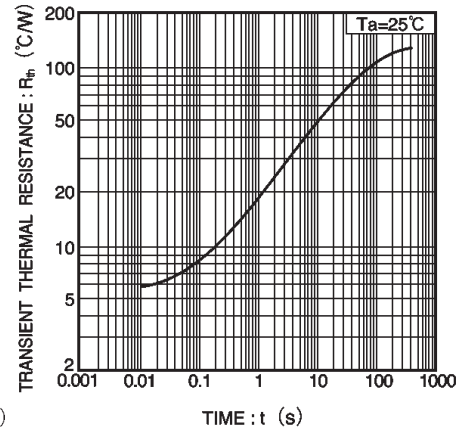


Fig.12 Transient thermal resistance (2SD1858)